## **SMD Switch SI-C3426A-6515**

#### Features

#### Applications

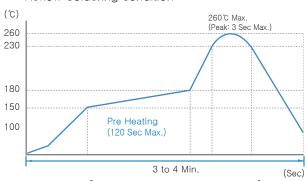


#### General specification

- Operating temperature: -30°C ~ +85°C, 45~85%RH
- Storage temperature:  $-30\,^{\circ}\text{C} \sim +85\,^{\circ}\text{C}$ ,  $45\sim85\%\text{RH}$
- Switch Type: Surface mount
- Operating direction: Vertical
- Minimum packing unit(pcs): 7,000pcs
- Electrical characteristics
- Insulation resistance: 100mΩ min. 100V DC
- Contact resistance: 250V AC, 1minute
- Rating: 50mA 12V DC
- Environmental specification
- Resistance to low temperature: -30±2℃, 96hr
- Heat resistance: 80±2°C, 96hr

#### Soldering conditions

• Reflow Soldering condition

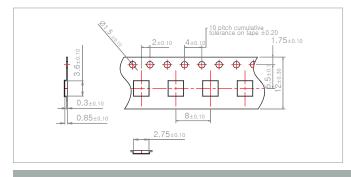


[Time inside soldering equipment]

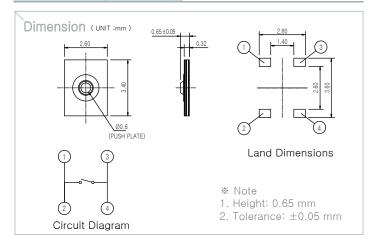
#### Manual condition

Item	Condition
Soldering temperature	350 °C max
Duration of soldering	3 sec max.
Capacity of soldering iron	60W max.

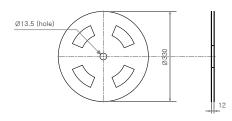
#### Packing specification



#### Type Surface mount Operating force 150gf ± 30 Operating direction Vertical 0.20 ± 0.1mm Travel Operating life (50mA 12V DC) 100,000 cycles Initial contact resistance 200 mΩ max. Minimum order unit (pcs.) 7,000pcs / Reel Series type Sharp feeling type Operating temperature range -30°C to +85°C Rating (max.) 50mA 12V DC Rating (min.) 10 μ A 1V DC Insulation resistance 100 mΩ min. 100V DC Electrical perforance Contact resistance 250V AC for 1 minute 10 to 55 to 10Hz/min., the amplitude is 1.5mm for all Durability Vibration the frequencies, in the direction of X, Y and Z for 2 houres respectively Cold -30°C±2°C for 96h Environmental perfomance Dry heat 80°C±2°C for 96h 60°C±2°C, 90 to 95%rhRH for 96h Damp heat



#### Standard Reel Dimensions (mm)



#### Packing unit: 7,000pcs/Reel

\*Operation feeling shall be measured after 20times pre-operations tor Dome s/w center.

Issue No : 2012. 07. 02
Issue Date : 2012. 07. 02

# [SPECIFICATION] (APPROVAL SHEET)

Model Name : SI-C3426A-6515

Divi	sion	Drawing up	Checked	Approved
Customer	Signature			
	Date	/	/	/
Supplier	Signature	1	(g)	(4)25
	Date	7 / 2	7 / 2	7 / 2

#### 1. General Specification:

1-1. Operating temperature rang: -30°C ~ +85°C

1-2. Storage temperature rang: -30°C ~ +80°C

1-3. Rating: 50mA 12V DC(Max.)

#### 2. Appearance, style and dimensions

-. Appearance : There shall be no defects that affect the serviceability of the product.

-. Style and dimensions : Refer to the assemble drawings.

3. Style of actuating : Tactile feedback

4. Contact arrangement : 1 pole 1 throw

#### 5. Electrical characteristics

Items	Test conditions	Criteria
1) Contact resistance	Push force: Operation force ×2 Test Method: Capable of 10, 4^10 mA with Contact resistance meter	500mΩ Max.
2) Withstand voltage	Test Method:250V/AC(50Hz~60Hz) for 1minute between terminals or frame	There shall be no breakdown
3) Insulation resistance	Test Method :100V/DC(50Hz~60Hz) between terminals or frame	100MΩ Min.
4) Bounce	Lightly striking the center of the stem at a rate encountered in normal use (3 ~ 4 times /sec) , bounce shall be tested at "On" and Off"  "ON" "OFF"  5V/DC 10k\Q Oscillo scope 1mA 10ms max.	"ON bounce: 10msec Max. "OFF bounce: 10msec Max.

#### 6. Mechanical characteristics

	Measured operation force at stop point when pushed dome s/w center.	
1) Operation force	O.F (CP) R.F (RL) S1 S2 travel (mm) Force characteristic	150±30gf
2) Travel to closure	Measured distance from switch top to stop point when pushed switch center.	0.20±0.1mm
3) Return force	The sample is installed such that the direction of switch operation is vertical and upon depression of the stem in its center the whole travel distance, the force of the stem to return tot its free position shall be measured.  Refer to fig < 1) item>	30gf Min.
4) Life cycles	1)Operating speed : 2~3 times/s 2)Force : 300kgf 3)Duration : 100,000 times	6 Item shall be satisfied and mechanical value within ±50% before testing
5) Strength adhesive actuator	Actuator(Boss)  Switch  PCB or Flat  Tested strength adhesive actuator as the fig  1)Test load: 3 N  2)Time: 15 sec	No fall apart and no separate.
6) Side push strength (soldering strength)	After reflow process  1)Push strength: 3kg  2)Time: 15sec  Switch  PCB  0.1mm	No damage (electrical and mechanical)
7) Stop strength	Placing the switch such that direction of switch operation is vertical and then a below static load shall be applied in the direction of stem operation.  (1) Depression: 3kgf (2) Time: 15 sec	There shall be no sine of damage mechanically and electrically

## 7. Environmental specification

1) Resistance to low temperature	1)Temperature : -30℃±2℃ 2)Time : 96h 3)Water drops shall be removed and made normal conditions for 1hour before measurement.	Contact resistance: 1000mΩ Max. 5 Item to 6 Item shall be satisfied
2) Heat resistance	1)Temperature : +80°C±2°C 2)Time : 96h 3)Made normal conditions for 1hour before measurement.	Contact resistance: 1000mΩ Max. 5 Item to 6 Item shall be satisfied
3) Change of Temperature	1)Test cycles: 5cycles as below 2)Water drops shall be removed and made normal conditions for 1hour before measurement  6h  +60°C  2h 1h 2h 1h	Contact resistance: 1000mΩ Max. 5 Item to 6 Item shall be satisfied
4) Humidity test	1)Temperature : 60°C±2°C 2)Relative humidity : 90%~95% 3)Time : 96h 4)Water drops shall be removed and made normal conditions for 1hour before measurement.	Contact resistance: 1000mΩ Max. 5 Item to 6 Item shall be satisfied
5) Salt spray test	1)Temperature : 35℃±2℃ 2)Solution : 5±1% , NaCl 3)Time : 48±1h 4)Water drops shall be removed and made normal conditions for 1hour before measurement.	Contact resistance: 1000mΩ Max. 5 Item to 6 Item shall be satisfied
6) Soldering Heat test	Mount the switch on P.W.B or P.C.B by adhesive.  1)Reflow process 2 times (Refer to reflow process conditions) Standard conditions after test: 1h	Contact resistance: 1000mΩ Max. 5 Item to 6 Item shall be satisfied
7) Water proof	1)Solution : METHYL ORANGE 2)Time : 48h 3)Water drops shall be removed.	No infiltrate water into inside switch

#### **Soldering** conditions

#### 1. Manual condition

1-1. Temperature and Time: 350°C Max and 3 Sec Max.

1-2. Capacity of soldering iron: 60W

#### 2. Reflow soldering

1-1. Preheating time: 60s max.

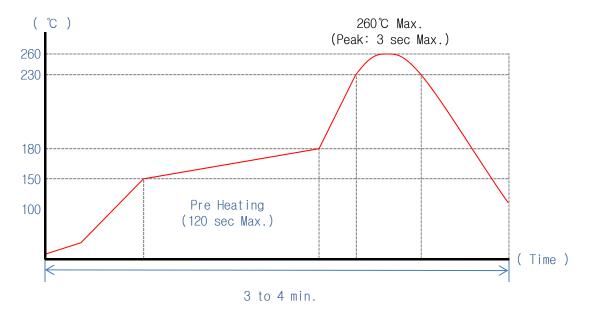
1-2.Temperature: 260°C max.

1-3. Dippping time: 3s max.

1-4. Soldering time: 2 times max.

1-5. The thickness of cream solder :  $0.15^{\circ}$  0.2mm

Reflow soldering condition



Time inside equipment soldering

#### Packaging

1. Refer to attached a drawing

2. Packing unit : 7,000pcs/REEL

#### Precaution in use

#### 1.General:

- 1) This product has been designed and manufactured for general electronic devices, such as audio, video, mobile phone, camera and etc.
- 2) This product is designed and manufactured assuming that it is to be use with the resistance for direct current. If you use other kinds of resistance or capacitive, please let us know beforehand.

#### 2. Soldering and assemble to PC board process

- 1) Note that if the load is applied to the terminals during soldering

  They might suffer deformation and defects in electrical performance.
- 2) Conditions of soldering shall be confirmed under actual production conditions.
- 3) Avoid consecutive of soldering. If consecutive of soldering or heating, click rate may deteriorate, so please performed in the shortest period and the lowest temperature possible.
- 4) Please let us know, especially when you use any other method of soldering except recommended one.
- 5) Please refer to manual condition when you re-soldering

#### 3. Washing process

1) Do not try to clean the switch with a solvent or the like.

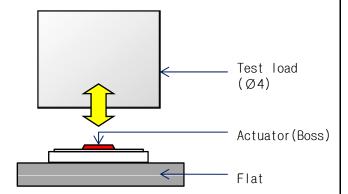
#### 4. Mechanism design

1) The dimensions of a hole and pattern for mounting a printed circuit board shall refer to the recommended dimensions in the engineering drawings.

#### 5. Measurement Conditions

#### 1) Operation force, Click Test Conditions

- -. Operation feeling shall be measured after 20times pre-operations for dome s/w center.
- -. It is recommended that tip of the keying section is flat.
- -. Allowable inclination of keying section : 90  $\pm 3$  degrees or les.



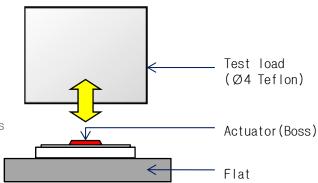
### 2) Life Test Conditions

-. Operating speed : 2times/s

-. Push force : 300gf

-. Duration : 100,000 times

-. About 0.3~0.5mm after leaving space, operates from the condition where the switch has become the junction.



#### 6. Others

- 1) If the switch is given stress from the side, it may result in damages to switch functions. therefore please handle it with extreme care. When the switch is carried, any shock shall not be applied to the switch.
- 2) Do not push except the actuating area.
- 3) Do not use the product in a manner that the switch is kept being pressed.

